

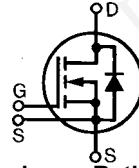
HiPerFET™ Power MOSFETs

IXFN 200 N06
IXFN 200 N07

V _{DSS}	I _{D25}	R _{DS(on)}
60 V	200 A	6 mΩ
70 V	200 A	6 mΩ

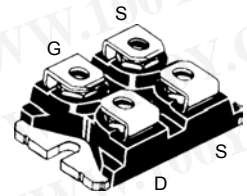
N-Channel Enhancement Mode
Avalanche Rated, High dv/dt, Low t_{rr}

t_{rr} ≤ 250 ns



Symbol	Test Conditions	Maximum Ratings	
V _{DSS}	T _J = 25°C to 150°C	N07	70 V
V _{DGR}	T _J = 25°C to 150°C; R _{GS} = 1 MΩ	N06	60 V
V _{GS}	Continuous		±20 V
V _{GSM}	Transient		±30 V
I _{D25}	T _C = 25°C; Chip capability	200N06	200 A
I _{L(RMS)}	Terminal current limit		100 A
I _{DM}	T _C = 25°C, pulse width limited by T _{JM}		600 A
I _{AR}	T _C = 25°C		100 A
E _{AR}	T _C = 25°C		30 mJ
E _{AS}	T _C = 25°C		2 J
dv/dt	I _S ≤ I _{DM} , di/dt ≤ 100 A/μs, V _{DD} ≤ V _{DSS} , T _J ≤ 150°C, R _{GS} ≥ 2 Ω		5 V/ns
P _D	T _C = 25°C		520 W
T _J			-55 ... +150 °C
T _{JM}			150 °C
T _{stg}			-55 ... +150 °C
V _{ISOL}	10/50 Hz, RMS I _{ISOL} ≤ 1 mA	t = 1 min t = 1 s	- 2500 V~ - 3000 V~
M _d	Mounting torque Terminal connection torque		1.5/13 Nm/lb.in. 1.5/13 Nm/lb.in.
Weight			30 g

miniBLOC, SOT-227 B (IXFN)
E153432



G = Gate D = Drain
S = Source
Either Source terminal at miniBLOC can be used as Main or Kelvin Source

Features

- International standard packages
- miniBLOC with Aluminium nitride isolation
- Low R_{DS(on)} HDMOS™ process
- Rugged polysilicon gate cell structure
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
- Fast intrinsic Rectifier

Applications

- DC-DC converters
- Synchronous rectification
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- Temperature and lighting controls
- Low voltage relays

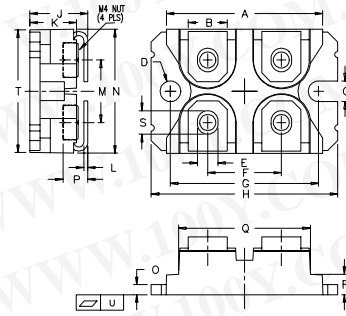
Advantages

- Easy to mount
- Space savings
- High power density

Symbol	Test Conditions		Characteristic Values (T _J = 25°C, unless otherwise specified)		
			min.	typ.	max.
V _{DSS}	V _{GS} = 0 V, I _D = 1 mA	N06 N07	60 70		V
V _{GS(th)}	V _{DS} = V _{GS} , I _D = 8 mA		2		4 V
I _{GSS}	V _{GS} = ±20 V _{DC} , V _{DS} = 0				±200 nA
I _{DSS}	V _{DS} = 0.8 • V _{DSS} , V _{GS} = 0 V, T _J = 125°C		2		400 μA
R _{DS(on)}	V _{GS} = 10 V, I _D = 0.5 • I _{D25} Pulse test, t ≤ 300 μs, duty cycle d ≤ 2 %				6 mΩ

Symbol	Test Conditions	Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified)		
		min.	typ.	max.
g_{fs}	$V_{DS} = 10\text{ V}; I_D = 0.5 \cdot I_{D25}$, pulse test	60	80	S
C_{iss}	$V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$		9000	pF
C_{oss}			4000	pF
C_{rss}			2400	pF
$t_{d(on)}$	$V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$ $R_G = 1\ \Omega$ (External),		30	ns
t_r			60	ns
$t_{d(off)}$			100	ns
t_f			60	ns
$Q_{g(on)}$	$V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$		480	nC
Q_{gs}			60	nC
Q_{gd}			240	nC
R_{thJC}	miniBLOC, SOT-227 B		0.24	K/W
R_{thCK}	miniBLOC, SOT-227 B		0.05	K/W

miniBLOC, SOT-227 B



M4 screws (4x) supplied

Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	31.50	31.88	1.240	1.255
B	7.80	8.20	0.307	0.323
C	4.09	4.29	0.161	0.169
D	4.09	4.29	0.161	0.169
E	4.09	4.29	0.161	0.169
F	14.91	15.11	0.587	0.595
G	30.12	30.30	1.186	1.193
H	38.00	38.23	1.496	1.505
J	11.68	12.22	0.460	0.481
K	8.92	9.60	0.351	0.378
L	0.76	0.84	0.030	0.033
M	12.60	12.85	0.496	0.506
N	25.15	25.42	0.990	1.001
O	1.98	2.13	0.078	0.084
P	4.95	5.97	0.195	0.235
Q	26.54	26.90	1.045	1.059
R	3.94	4.42	0.155	0.174
S	4.72	4.85	0.186	0.191
T	24.59	25.07	0.968	0.987
U	-0.05	0.1	-0.002	0.004

Symbol	Test Conditions	Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified)		
		min.	typ.	max.
I_S	$V_{GS} = 0\text{ V}$			200 A
I_{SM}	Repetitive; pulse width limited by T_{JM}			600 A
V_{SD}	$I_F = 100\text{ A}, V_{GS} = 0\text{ V}$, Pulse test, $t \leq 300\ \mu\text{s}$, duty cycle $d \leq 2\%$			1.7 V
t_{rr}	$I_F = 25\text{ A}$ $-di/dt = 100\text{ A}/\mu\text{s}$, $V_R = 50\text{ V}$		150	250 ns
Q_{RM}			0.7	μC
I_{RM}			9	A

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IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:

4,835,592	4,881,106	5,017,508	5,049,961	5,187,117	5,486,715	6,306,728B1
4,850,072	4,931,844	5,034,796	5,063,307	5,237,481	5,381,025	